# **Preliminary**



RFM products are now Murata products.

- SF2177E-3

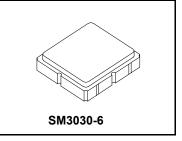
- · Low-loss SAW Filter
- Surface-mount 3.0 x 3.0 x 1.4 mm Package
- Complies with Directive 2002/95/EC (RoHS)



#### Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	15	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C





#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	F <sub>C</sub>			1472		MHz
Max Insertion Loss, 1452 to 1492 MHz	IL			1.5	2.0	dB
Passband Ripple, 1452 to 1492 MHz				0.7	1.2	dB <sub>P-P</sub>
1dB BW	BW		40	61		MHz
Group Delay Variation, 1452 to 1492 MHz				9.5	15	nsec
VSWR, 1452 to 1942 MHz				1.9	2.2	
Attenuation Referenced to 0 dB						
10 to 1000 MHz			30	33		dB
1710 to 2500 MHz			30	39		
Terminating Source Impedance (single ended)	ZS			50		Ω
Terminating Load Impedance (single ended)	ZL			50		Ω

Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	A90, YWWS
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel
Reel Size 13 Inch	3000 Pieces/Reel

#### **Electrical Connections**

Connection	Terminals
Input	2
Output	5
Ground	All Others



## CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

#### Notes:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external
- impedance matching design. See Application Note No. 42 for details.

  "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

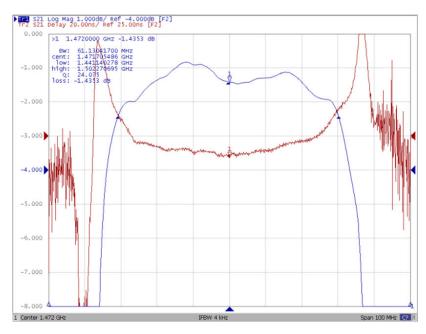
  The design, manufacturing process, and specifications of this filter are subject to change.

  Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

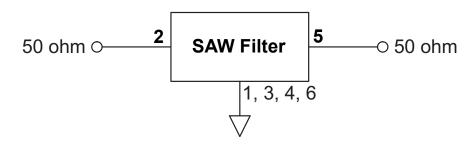
## Filter Wideband Response (span 2490 MHz)



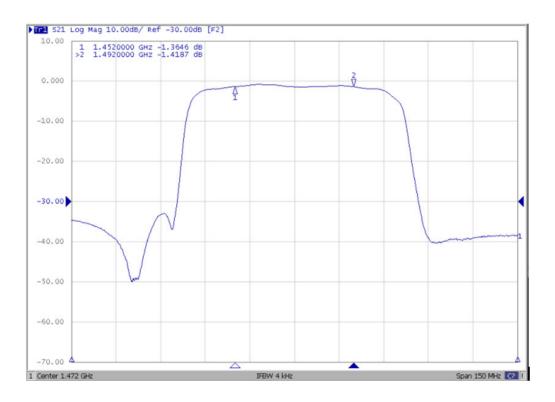
## Filter Passband Response (span 1000 MHz)



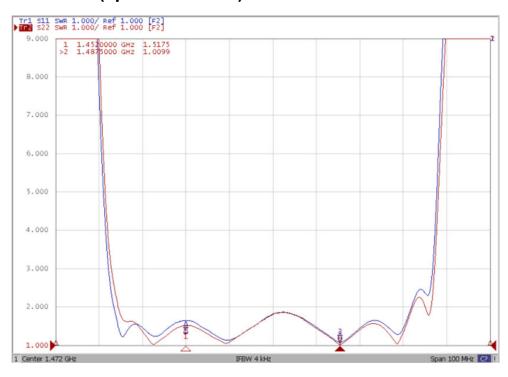
### **Filter Test Circuit**



## S21 Response (span 150 MHz)

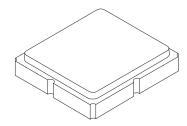


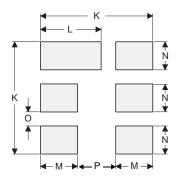
## \$11 &\$22 VSWR (span 1000 MHz)



## **SM3030-6 Case**

# 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





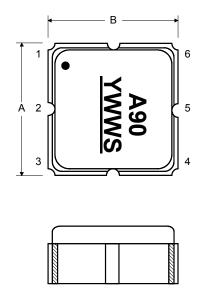
**PCB Footprint Top View** 

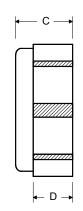
### **Case and PCB Footprint Dimensions**

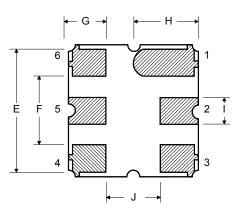
Dimension		mm			Inches	
Dimension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.4	0.044	0.049	0.055
D	0.77	0.90	1.00	0.030	0.035	0.039
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	
Р		1.09			0.042	

#### **Case Materials**

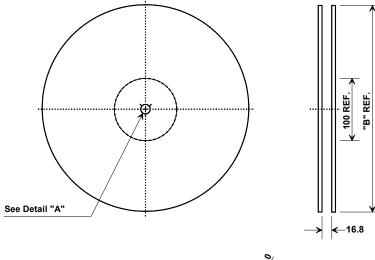
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				



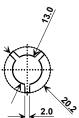




## **Tape and Reel Specifications**

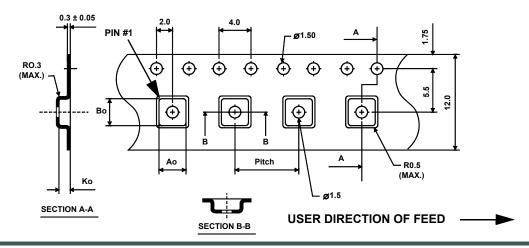


"B"		Quantity Per Reel	
Inches	millimeters	<b></b>	
7	178	500	
13	330	3000	



#### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions	
Ao	3.30 mm
Во	3.30 mm
Ko	1.6 mm
Pitch	8 mm
W	12 mm



## **Typical Solder Reflow Profile**

